



Dual-coupling-guided epitaxial growth of wafer-scale single-crystal WS₂ monolayer on vicinal *a*-plane sapphire

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The growth of wafer-scale single-crystal two-dimensional transition metal dichalcogenides (TMDs) on insulating substrates is critically important for a variety of high-end applications^{1–4}. Although the epitaxial growth of wafer-scale graphene and hexagonal boron nitride on metal surfaces has been reported^{5–8}, these techniques are not applicable for growing TMDs on insulating substrates because of substantial differences in growth kinetics. Thus, despite great efforts^{9–20}, the direct growth of wafer-scale single-crystal TMDs on insulating substrates is yet to be realized. Here we report the successful epitaxial growth of two-inch single-crystal WS₂ monolayer films on vicinal *a*-plane sapphire surfaces. In-depth characterizations and theoretical calculations reveal that the epitaxy is driven by a dual-coupling-guided mechanism, where the sapphire plane–WS₂ interaction leads to two preferred antiparallel orientations of the WS₂ crystal, and sapphire step edge–WS₂ interaction breaks the symmetry of the antiparallel orientations. These two interactions result in the unidirectional alignment of nearly all the WS₂ islands. The unidirectional alignment and seamless stitching of WS₂ islands are illustrated via multiscale characterization techniques; the high quality of WS₂ monolayers is further evidenced by a photoluminescent circular helicity of ~55%, comparable to that of exfoliated WS₂ flakes. Our findings offer the opportunity to boost the production of wafer-scale single crystals of a broad

range of two-dimensional materials on insulators, paving the way to applications in integrated devices.

Wafer-scale single-crystal films of two-dimensional (2D) transition metal dichalcogenides (TMDs) are essential for high-end device applications. The seamless coalescence of millions of unidirectionally aligned 2D islands on a single-crystal substrate has been proven to be a suitable method for the growth of wafer-scale 2D single crystals^{5–8}. However, in the case of TMDs, the direct growth of monolayer single-crystal films on a wafer-scale insulating substrate has not been achieved in spite of some progress in orientation control in the past decade^{9,10}. The challenge is mainly because of the non-centrosymmetric C_{3v} lattice of TMDs, which generally leads to the equivalency of antiparallel islands on most high-symmetry surfaces¹⁵. Hence, new methods need to be developed for the unidirectional alignment of TMD islands on insulators.

In principle, as TMDs and hexagonal boron nitride (hBN) lattices have the same in-plane symmetry, the successful epitaxy of 2D hBN can offer important clues to obtain large-area epitaxial TMD single crystals^{6–8}. However, the unidirectional alignment of hBN islands was achieved on metallic substrates by taking advantage of the strong coupling between the hBN edge and step edge on the transition metal surface. Such a strong edge–step edge coupling may not be feasible when growing TMDs on an insulating surface because of the self-passivation of the TMD edge and the inert surface of the insulator^{21,22}. Therefore, the mechanism of the epitaxy of

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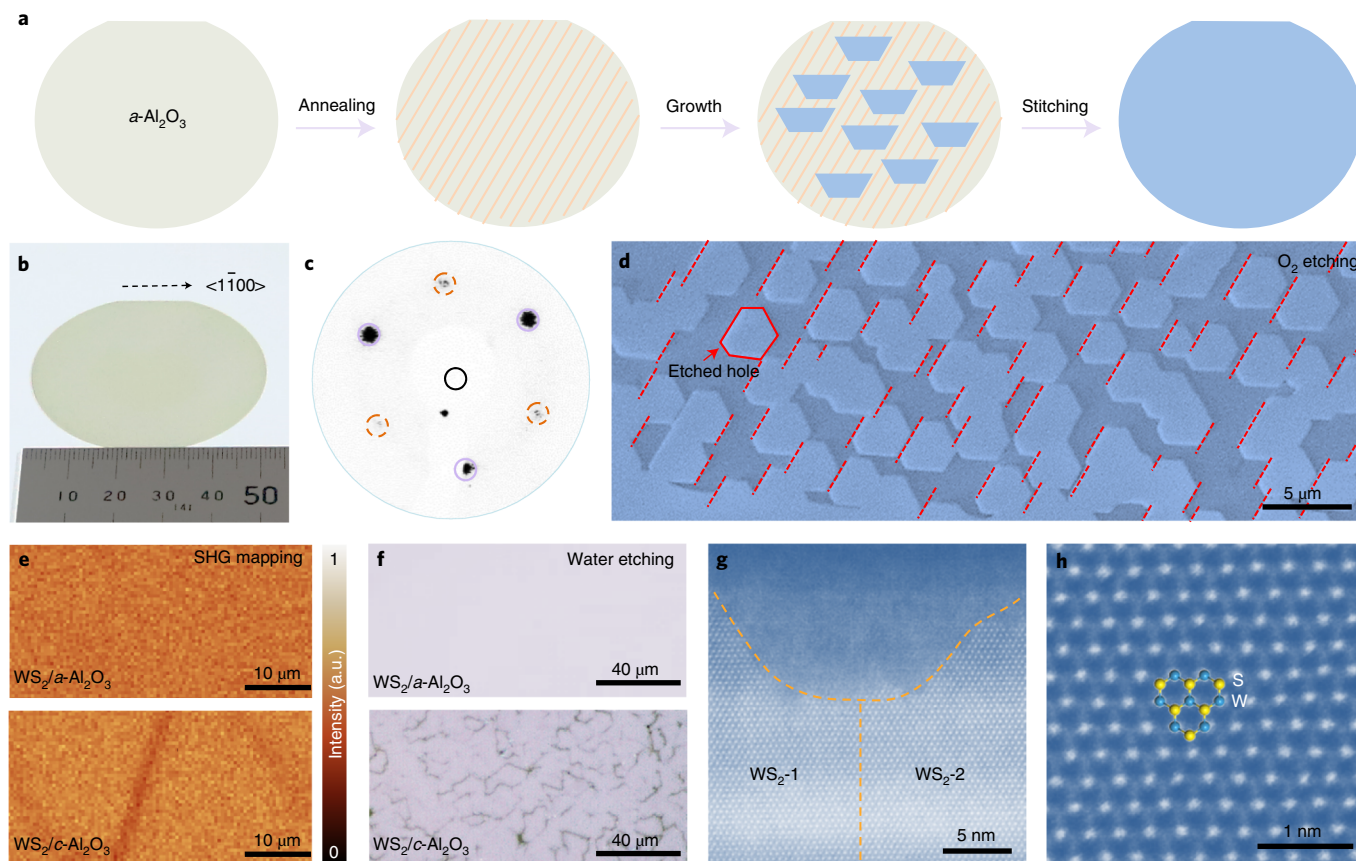


Fig. 1 | Growth and characterization of single-crystal WS₂ monolayer on vicinal *a*-plane sapphire. **a**, Schematic of the growth process of a WS₂ monolayer on vicinal *a*-plane sapphire (abbreviated as *a*-Al₂O₃). **b**, Photograph of the as-grown WS₂ monolayer on a two-inch sapphire wafer. The direction of the straight edge is $\langle 1\bar{1}00 \rangle$. **c**, Representative LEED pattern of the WS₂ film (as measured at position 1 shown in Supplementary Fig. 6a). Due to the three-fold rotational symmetry, three diffraction spots have a higher intensity (solid violet circles) than three other spots (dashed orange circles). **d**, False-colour SEM image of WS₂ films after O₂ etching. The etched holes have similar shapes and the same orientation. **e**, SHG mapping of WS₂ grown on *a*-Al₂O₃ (top) and *c*-Al₂O₃ (bottom). **f**, Optical images of WS₂ film grown on *a*-Al₂O₃ (top) and *c*-Al₂O₃ (bottom) after hot water vapour etching. No boundaries are observed for WS₂/*a*-Al₂O₃, but boundaries can be clearly seen in WS₂/*c*-Al₂O₃. **g**, Atomically resolved STEM image from the merged area of the two aligned WS₂ islands (namely, WS₂-1 and WS₂-2), showing that no boundary was formed. **h**, Atomically resolved STEM image of the high-quality WS₂ lattice.

2D TMDs on an insulating surface might be substantially different from that on a metal surface.

Here we demonstrate a few rules as guidelines to choose a proper insulating substrate. First, the insulating surface should have low symmetry to break the energy degeneracy of two antiparallel TMD islands²³. Second, it should be possible to obtain an atomically flat surface with uniformity on the wafer scale and thereby ensure a uniform, intimate contact between the 2D materials and the substrate. Referring to the established growth philosophy of aligned carbon nanotubes on sapphire²⁴, we decided to employ a single-crystal sapphire substrate cut along a plane that has a very small angle from the (11 $\bar{2}$ 0) surface, or vicinal *a*-plane sapphire (referred to as *a*-Al₂O₃, if not specified otherwise). This kind of sapphire substrate was custom-designed and fabricated by a local supplier, which allowed us to obtain *a*-Al₂O₃ with a cutting angle as small as 0.1° along a certain direction (Methods and Supplementary Figs. 1 and 2 provide details).

The sapphire substrates were first annealed in an oxygen (O₂) atmosphere at a high temperature to stabilize the parallel atomic steps, which typically have a width of 350 nm and height of 2 Å on the surface (Supplementary Fig. 3). These atomic step edges are designed to break the C₂ symmetry of *a*-plane sapphire and guide the unidirectional alignment of WS₂ islands for the epitaxial growth

of the single-crystal monolayer film (Fig. 1a). The prevailing recipe for WS₂ monolayer growth was adopted (Methods), and a complete WS₂ monolayer film on a two-inch sapphire wafer was successfully synthesized (Fig. 1b and Supplementary Figs. 4 and 5).

To evaluate whether the film is formed by unidirectionally aligned WS₂ domains, characterizations including low-energy electron diffraction (LEED), second-harmonic generation (SHG) and O₂ etching were performed. Three diffraction spots have a higher intensity (indicated by solid violet circles in Fig. 1c) than three other spots (indicated by dashed orange circles in Fig. 1c) due to the three-fold rotational symmetry of WS₂, which is strong proof of the unidirectional alignment of different domains in the film (Fig. 1c and Supplementary Fig. 6). The parallelly aligned holes in the WS₂ film after O₂ etching (Fig. 1d, Supplementary Fig. 7a–d for single-crystal WS₂, and Supplementary Fig. 8 for polycrystalline WS₂), as well as the nearly identical polarization-dependent SHG patterns (Supplementary Fig. 7e–h), further confirmed that the film has no misaligned domains.

Several characterization techniques ranging from the macroscopic scale to the atomic scale have been used to confirm that parallel WS₂ islands were seamlessly stitched together without forming grain boundaries. In the large scale, the grain boundaries could be visualized by SHG mapping²⁵ (destructive interference at the

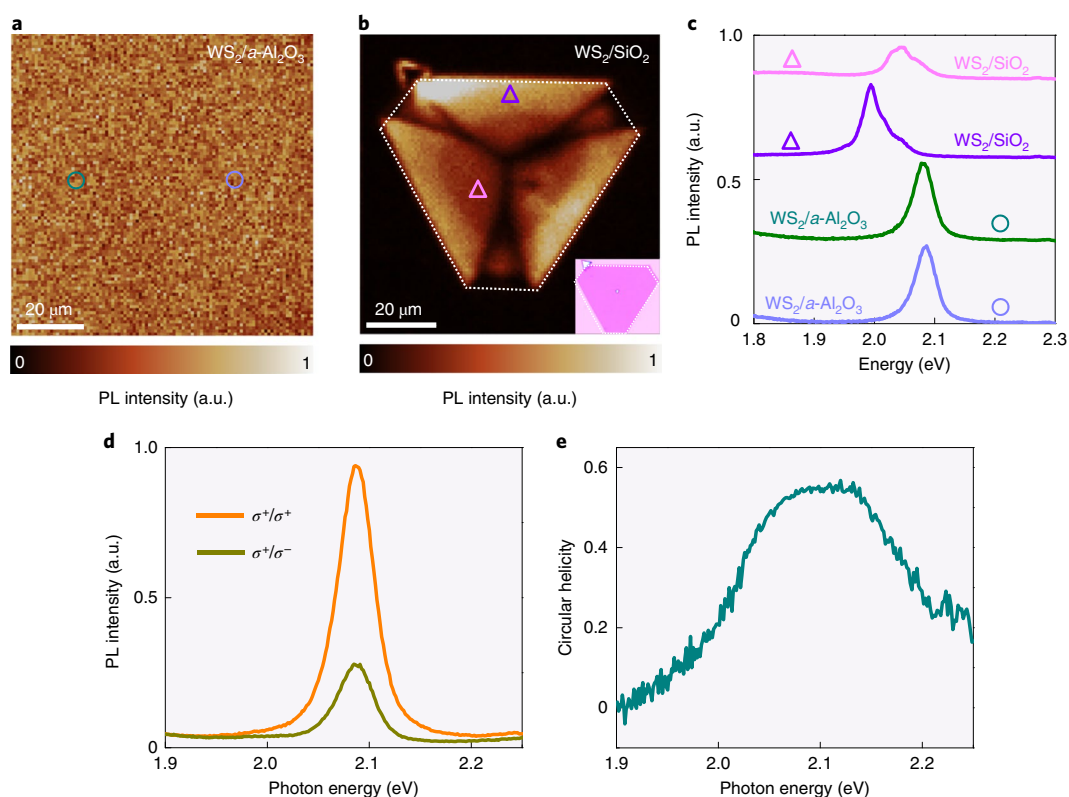


Fig. 2 | High-quality WS₂ monolayer grown on vicinal α -plane sapphire. **a**, Typical PL mapping of a WS₂ film grown on α -Al₂O₃. The PL intensity is uniform in the whole area. **b**, Typical PL mapping of a single-crystal WS₂ island grown on SiO₂/Si substrate. Inset: optical image of the WS₂ domain in **b**. **c**, PL spectra of WS₂ at the positions marked by circles and triangles in **a** and **b**. Many side peaks that can be assigned to trion and defect states are observed for WS₂/SiO₂. Further, the PL spectra of WS₂/ α -Al₂O₃ show a single narrow peak corresponding to the exciton state in high-quality materials. **d**, Circularly polarized PL spectra of WS₂ grown on α -plane sapphire. The excitation light is right-handed (σ^+) circularly polarized at 2.34 eV. Left-handed (σ^-) and right-handed (σ^+) circularly polarized PL spectra are shown in dark yellow and orange, respectively. **e**, Circular helicity calculated from the PL spectra in **d**. The high value over 55% indicates the high quality of our WS₂ monolayer. All the PL spectra and mappings were measured at 7.5 K.

boundary shows dark lines) or hot water vapour etching (the defective boundaries are etched to show dark lines). For the WS₂ film grown on α -Al₂O₃, no boundaries were observed in either SHG mapping (Fig. 1e, top, and Supplementary Fig. 9a,b) or water etching mapping (Fig. 1f, top). In contrast, obvious boundaries appeared for the film grown on the c -Al₂O₃ surface¹⁵ (Fig. 1e, bottom; Supplementary Fig. 9c,d for SHG mapping; and Fig. 1f, bottom, for water etching). In Fig. 1g,h, the aberration-corrected transmission electron microscopy (TEM) image and dark-field TEM image clearly showed atomic evidence of the seamless stitching between adjacent WS₂ islands (Supplementary Figs. 10 and 11 provide further details). Theoretically, our calculations demonstrated that forming a perfect WS₂ crystal lattice between two parallelly aligned WS₂ islands is much more energetically preferred than forming grain boundaries (Supplementary Figs. 12 and 13); this perfect grain stitching has also been experimentally demonstrated during the coalescence of other 2D materials of graphene and hBN (refs. 5,6). However, it is actually very difficult to identify all the defects through two-inch films, as existing characterization techniques are limited to a very small area. Therefore, WS₂ films may contain line defects in the coalescence of millions of islands.

The exceptionally high quality of the obtained large-area single-crystal WS₂ monolayer was demonstrated using several different characterization techniques. First, a statistical analysis of the atomic aberration-corrected TEM images showed that the grown WS₂ is of high quality with a sulfur (S) vacancy concentration of ~ 0.05 per square nanometre, which is about half of the reported

values^{26,27} (Supplementary Fig. 14). Second, the low-temperature photoluminescence (PL) map of the WS₂ film grown on α -Al₂O₃ shows extremely uniform intensity (Fig. 2a), with a narrow distribution of peak widths and identical peak energy at different positions on the sample (Fig. 2c). In comparison, the PL map of a WS₂ island grown on SiO₂/Si substrates has a non-uniform intensity distribution and both peak widths and energies of the PL spectra depend on the location (Fig. 2b,c). The identical PL peak in our WS₂/ α -Al₂O₃ is assigned to the pure exciton state in a high-quality material, whereas the side peaks in WS₂/SiO₂ are assigned to trion and defect states in a relatively lower-quality material²⁸.

Third, our WS₂/ α -Al₂O₃ had a very high circular helicity in the circularly polarized PL spectrum, another strong proof of its high quality, since the circular helicity arises from the valley freedom at the K and K' points of the Brillouin zone and is very sensitive to any defect that will introduce intervalley scattering to degrade the circular helicity²⁹. For high-quality WS₂ monolayer flakes exfoliated from high-quality bulk single crystals, the measured circular helicity ($\rho = \frac{I_+ - I_-}{I_+ + I_-}$, where I_{\pm} is the intensity of the σ^{\pm} PL components) was generally lower than 40% (refs. 30–32), and the as-grown WS₂ monolayer on SiO₂/Si had typical circular helicity lower than 20% (Supplementary Fig. 15a,b). Strikingly, our WS₂/ α -Al₂O₃ had circular helicity up to 55% (Fig. 2d,e), competitive to those of the best exfoliated flakes.

Last, we checked the quality by electrical measurements. We first fabricated field-effect transistor (FET) devices following standard procedures with back-gate geometry. The results showed that

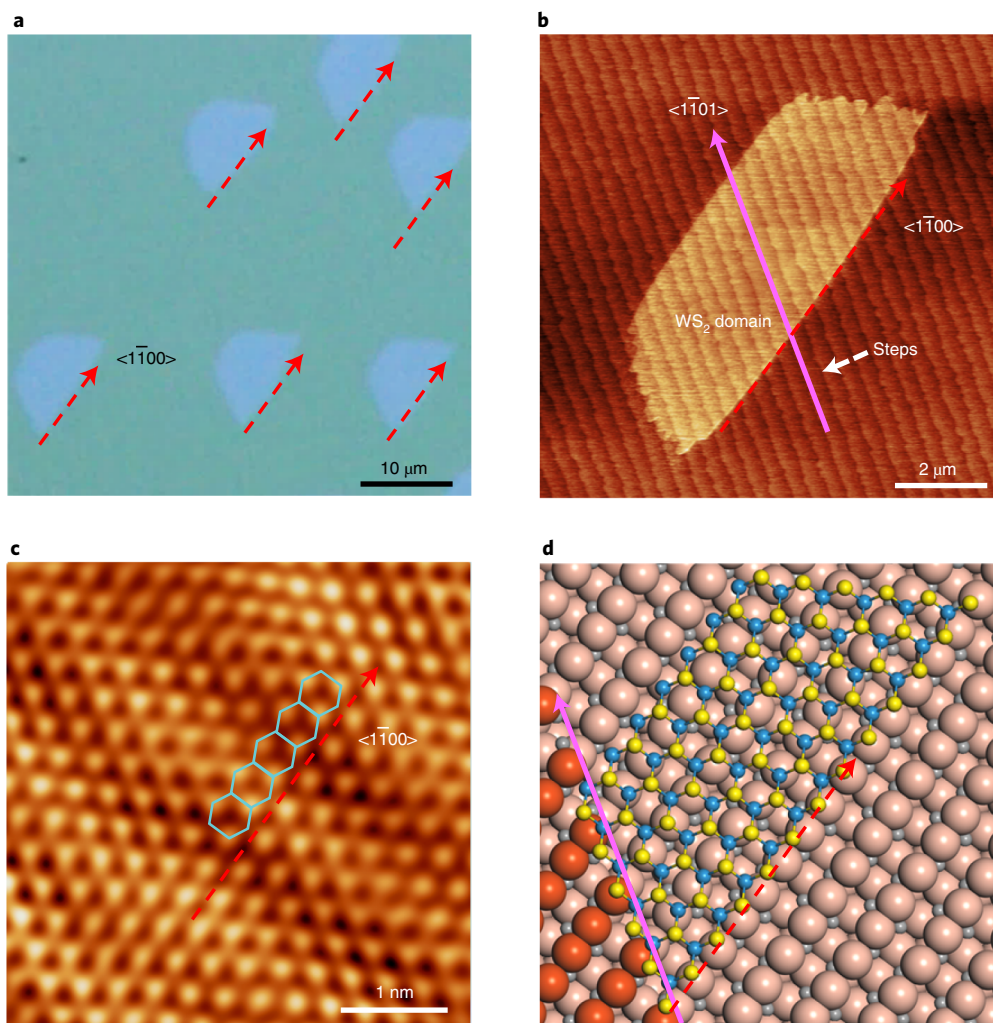


Fig. 3 | Characterization of WS₂ islands on vicinal *a*-plane sapphire. **a**, Optical image of individual WS₂ islands on *a*-Al₂O₃. All the islands are trapezoidal in shape with long edges along the $\langle 1\bar{1}00 \rangle$ direction of sapphire. **b**, AFM image of a WS₂ island. The direction of the Al₂O₃ steps is $\langle 1\bar{1}01 \rangle$. **c**, Zoomed-in atomically resolved AFM image of the WS₂ sample shown in **b**. The long zigzag edge of the hexagonal lattice of WS₂ is along the $\langle 1\bar{1}00 \rangle$ direction. **d**, Schematic of the atomic geometry of WS₂/*a*-Al₂O₃. The red and brown balls correspond to the first and second layer of O atoms from the surface, respectively. The grey balls correspond to Al atoms.

mobility of the WS₂ sample was about 0.8–1.6 cm²(V s)⁻¹ at room temperature (Supplementary Fig. 16a). This value is not very high as the quality of electrode contact of WS₂ is usually very poor, which greatly affects the measured mobility value. To check this assumption, we also fabricated FET devices with exfoliated WS₂ monolayers using the same procedures, and the results showed that the measured mobility of exfoliated WS₂ was not high as ~1.0–1.9 cm²(V s)⁻¹ (Supplementary Fig. 16b). To reduce the influence of electrode contact, we further fabricated ionic-liquid-gate FET and measured its electrical transport properties³³. The result showed that our WS₂ samples have a relatively large carrier mobility of ~50 cm²(V s)⁻¹ at 150 K (Supplementary Fig. 16c,d).

To deeply understand the mechanism of single-crystal WS₂ growth on the vicinal *a*-plane sapphire, we showed that the WS₂ islands formed in the initial stages of growth, as shown in Fig. 3a, where unidirectionally aligned islands—all of them having the same trapezoidal shape—are clearly seen. High-resolution atomic force microscopy (AFM) images of a typical WS₂ island further confirm the presence of parallel step edges as well as crystallinity (Fig. 3b,c). The longest edge of the trapezoidal WS₂ island is a zigzag edge along the $\langle 1\bar{1}00 \rangle$ direction of sapphire (Supplementary Figs. 17 and 18

provide details of the formation mechanism), rather than along the step-edge direction of $\langle 1\bar{1}01 \rangle$ of the sapphire surface. To confirm the epitaxial relationship of WS₂/*a*-Al₂O₃, glancing-angle X-ray diffraction was conducted and the result shows that the zigzag edge of WS₂ is parallel to the $\langle 1\bar{1}00 \rangle$ direction of *a*-Al₂O₃, which is consistent with our optical and AFM characterizations (Supplementary Fig. 19). This scenario is totally different from the step-edge-guided growth of hBN on vicinal Cu(110) surfaces, where the longest edge of a trapezoidal hBN island is tightly bound to the $\langle 211 \rangle$ step edge of the Cu surface⁶. Thus, we believe that the mechanism of the unidirectional alignment of WS₂ islands on the *a*-Al₂O₃ surface must be different from that of the alignment of graphene and hBN on metal surfaces.

Based on our theoretical analysis and density functional theory (DFT) calculations, we discover that the epitaxial alignment of WS₂ islands on the *a*-Al₂O₃ surface is governed by a dual-coupling-guided mechanism. The first driving force is the coupling between WS₂ and *a*-plane sapphire, which leads to two energetically degenerated antiparallel alignments of WS₂ islands (Fig. 4a,b and Fig. 4c, top). The second driving force is the coupling between WS₂ and the step edges of sapphire, where the step edges serve as active lines of the

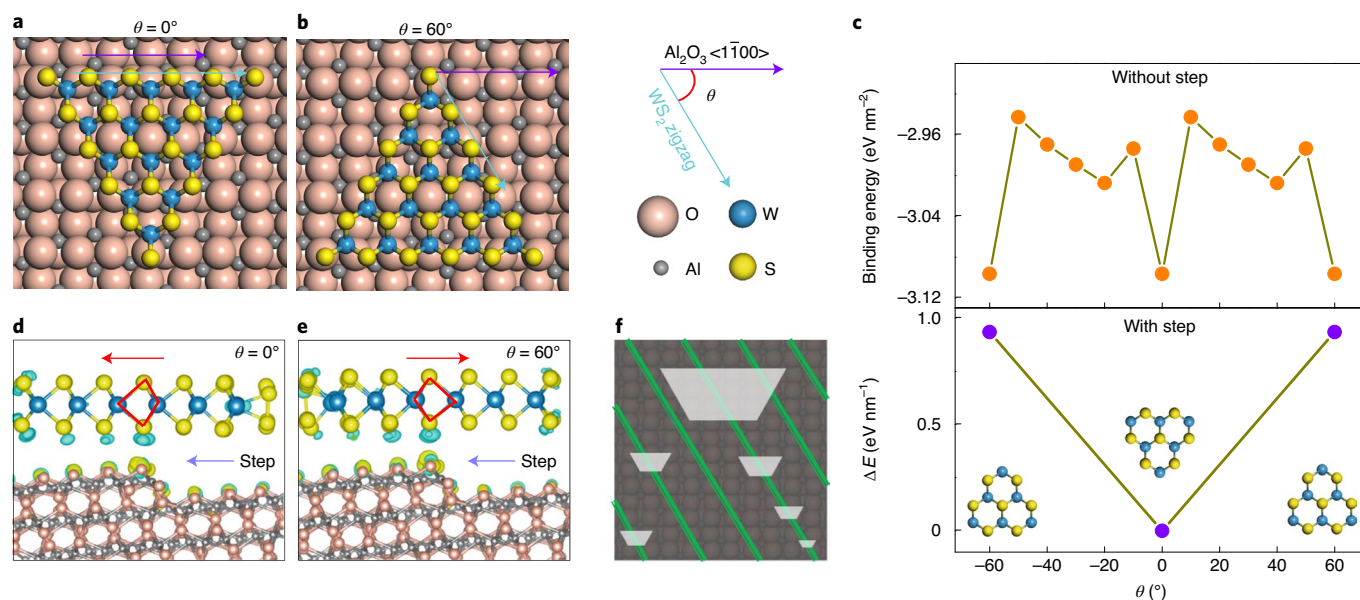


Fig. 4 | Dual-coupling-guided epitaxial growth of WS₂ monolayer on vicinal *a*-plane sapphire. **a, b**, Schematic of the configuration of WS₂ cluster on a flat *a*-plane sapphire surface for $\theta = 0^\circ$ (**a**) and $\theta = 60^\circ$ (**b**), where θ is the angle between one zigzag direction of WS₂ and the $\langle 1\bar{1}00 \rangle$ plane of the *a*-plane sapphire surface. **c**, Top: DFT calculations of the binding energies of a WS₂ triangular island with different rotation angles on the *a*-plane sapphire surface. The results show that the energy surface has two deep minima at $\theta = 0^\circ$ and $\theta = \pm 60^\circ$, which correspond to the configurations shown in **a**. Bottom: relative energy difference between two antiparallel WS₂ islands that cross a step edge on the *a*-plane sapphire surface due to symmetry breaking. **d, e**, Optimized structures of antiparallel WS₂ ribbons crossing an atomic step of *a*-plane sapphire (side view) for $\theta = 0^\circ$ (**d**) and $\theta = 60^\circ$ (**e**), in which the distributions of charge difference are also shown. The calculation showed that the binding energy between the step edge and WS₂ depends on its alignment and breaks the C_2 symmetry of the WS₂/*a*-plane sapphire system. Differences in the S–W–S bond direction are marked by red symbols and arrows. **f**, Schematic of WS₂ islands grown on *a*-Al₂O₃ during the early stage of growth. The driving force for both in-plane and edge coupling between WS₂ and sapphire leads to the unidirectional alignment of islands during the early growth stage.

a-Al₂O₃ surface to initiate the nucleation of WS₂ islands and break the degeneracy of the two antiparallel alignments of WS₂ islands on the ideal *a*-Al₂O₃ surface (Fig. 4d,e and Fig. 4c, bottom).

Quantitatively, our calculations estimate that the coupling strength between WS₂ and *a*-plane sapphire is ~ 200 meV per WS₂ formula unit, which is much larger than that on other insulating substrates (for example, ~ 80 meV per WS₂ formula unit for the (0001) surface of quartz). This relatively strong interaction is also demonstrated by the observed blue-shift in the PL peaks in as-grown WS₂ on *a*-Al₂O₃ (Supplementary Fig. 15c,d).

Furthermore, our DFT calculations clearly show that the interaction between WS₂ and step edge depends on the alignment of WS₂. Although two antiparallel WS₂ island crossing the step edge have almost the same shape, their interactions with the active step edge are fairly different (Fig. 4d,e). Therefore, the step edge reduces the symmetry of the substrate from C_2 to C_1 , and makes it possible to have all the WS₂ islands aligned only along one direction. For a WS₂ island having a contact length of ~ 5 nm with the step edge, the energy difference (ΔE) between the two antiparallel WS₂ islands reaches ~ 4 eV and the preferred alignment has a thermodynamic probability of $1 / \left(1 + \exp \left(\frac{\Delta E}{k_B T} \right) \right) > 99.99\%$, where k_B is the Boltzmann constant and $T = 1,238$ K is the growth temperature. During the initial nucleation stage, the WS₂ islands nucleate at the active step edges, which, in turn, strongly interact with the WS₂ islands. The low symmetry of the sapphire step edge allows to differentiate the two antiparallel alignments of the WS₂ islands across it; finally, only WS₂ islands with one type of alignment survive (Fig. 4f).

This dual-coupling-guided growth mechanism should, in principle, be applicable to grow other single-crystal TMD materials on insulators as well. Here we have given the examples of the epitaxy

of MoS₂, WSe₂ and MoSe₂ on *a*-Al₂O₃ (Supplementary Figs. 20–24). The successful growth of wafer-scale 2D TMD single crystals on insulating surfaces beyond graphene and hBN on transition metal surfaces provides the required cornerstone of 2D semiconductors in high-end applications of next-generation integrated optical and electronic devices.

Online content

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References

- Wang, Q. H. et al. Electronics and optoelectronics of two-dimensional transition metal dichalcogenides. *Nat. Nanotechnol.* **7**, 699–712 (2012).
- Radisavljevic, B. et al. Single-layer MoS₂ transistors. *Nat. Nanotechnol.* **6**, 147–150 (2011).
- Mak, K. F., McGill, K. L., Park, J. & McEuen, P. L. The valley Hall effect in MoS₂ transistors. *Science* **344**, 1489–1492 (2014).
- Jin, C. H. et al. Imaging of pure spin-valley diffusion current in WS₂-WSe₂ heterostructures. *Science* **360**, 893–896 (2018).
- Xu, X. Z. et al. Ultrafast epitaxial growth of metre-sized single-crystal graphene on industrial Cu foil. *Sci. Bull.* **62**, 1074–1080 (2017).
- Wang, L. et al. Epitaxial growth of a 100-square-centimetre single-crystal hexagonal boron nitride monolayer on copper. *Nature* **570**, 91–95 (2019).
- Lee, J. S. et al. Wafer-scale single-crystal hexagonal boron nitride film via self-collimated grain formation. *Science* **362**, 817–821 (2018).

8. Chen, T. A. et al. Wafer-scale single-crystal hexagonal boron nitride monolayers on Cu (111). *Nature* **579**, 219–223 (2020).
9. Chen, L. et al. Step-edge-guided nucleation and growth of aligned WSe₂ on sapphire via a layer-over-layer growth mode. *ACS Nano* **9**, 8368–8375 (2015).
10. Chubarov, M. et al. Wafer-scale epitaxial growth of unidirectional WS₂ monolayers on sapphire. *ACS Nano* **15**, 2532–2541 (2021).
11. Lee, Y. H. et al. Synthesis of large-area MoS₂ atomic layers with chemical vapor deposition. *Adv. Mater.* **24**, 2320–2325 (2012).
12. Najmaei, S. et al. Vapour phase growth and grain boundary structure of molybdenum disulphide atomic layers. *Nat. Mater.* **12**, 754–759 (2013).
13. van der Zande, A. M. et al. Grains and grain boundaries in highly crystalline monolayer molybdenum disulphide. *Nat. Mater.* **12**, 554–561 (2013).
14. Zheng, J. et al. High yield exfoliation of two-dimensional chalcogenides using sodium naphthalene. *Nat. Commun.* **5**, 2995 (2014).
15. Dumcenco, D. et al. Large-area epitaxial monolayer MoS₂. *ACS Nano* **9**, 4611–4620 (2015).
16. Gao, Y. et al. Large-area synthesis of high-quality and uniform monolayer WS₂ on reusable Au foils. *Nat. Commun.* **6**, 8569 (2015).
17. Zhou, J. D. et al. A library of atomically thin metal chalcogenides. *Nature* **556**, 355–359 (2018).
18. Yang, P. et al. Epitaxial growth of centimeter-scale single-crystal MoS₂ monolayer on Au (111). *ACS Nano* **14**, 5036–5045 (2020).
19. Li, J. et al. General synthesis of two-dimensional van der Waals heterostructure arrays. *Nature* **579**, 368–374 (2020).
20. Wang, Q. Q. et al. Wafer-scale highly oriented monolayer MoS₂ with large domain sizes. *Nano Lett.* **20**, 7193–7199 (2020).
21. Sang, X. H. et al. In situ edge engineering in two-dimensional transition metal dichalcogenides. *Nat. Commun.* **9**, 2051 (2018).
22. Kurita, T., Uchida, K. & Oshiyama, A. Atomic and electronic structures of α -Al₂O₃ surfaces. *Phys. Rev. B* **82**, 155319 (2010).
23. Dong, J. C., Zhang, L. N., Dai, X. Y. & Ding, F. The epitaxy of 2D materials growth. *Nat. Commun.* **11**, 5862 (2020).
24. Ismach, A., Segev, L., Wachtel, E. & Joselevich, E. Atomic-step-templated formation of single wall carbon nanotube patterns. *Angew. Chem. Int. Ed.* **43**, 6140–6143 (2004).
25. Cheng, J. X. et al. Chiral selection rules for multi-photon processes in two-dimensional honeycomb materials. *Opt. Lett.* **44**, 2141–2144 (2019).
26. Hong, J. H. et al. Exploring atomic defects in molybdenum disulphide monolayers. *Nat. Commun.* **6**, 6293 (2015).
27. Qiu, H. et al. Hopping transport through defect-induced localized states in molybdenum disulphide. *Nat. Commun.* **4**, 2642 (2013).
28. Wang, G. et al. In-plane propagation of light in transition metal dichalcogenide monolayers: optical selection rules. *Phys. Rev. Lett.* **119**, 047401 (2017).
29. Zeng, H. L. et al. Valley polarization in MoS₂ monolayers by optical pumping. *Nat. Nanotechnol.* **7**, 490–493 (2012).
30. Zhu, B. R. et al. Anomalously robust valley polarization and valley coherence in bilayer WS₂. *Proc. Natl Acad. Sci. USA* **111**, 11606–11611 (2014).
31. Scrace, T. et al. Magnetoluminescence and valley polarized state of a two-dimensional electron gas in WS₂ monolayers. *Nat. Nanotechnol.* **10**, 603–607 (2015).
32. Plechinger, G. et al. Trion fine structure and coupled spin-valley dynamics in monolayer tungsten disulfide. *Nat. Commun.* **7**, 12715 (2016).
33. Lu, J. M. et al. Evidence for two-dimensional Ising superconductivity in gated MoS₂. *Science* **350**, 1353–1357 (2015).

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Methods

Annealing of vicinal *a*-plane sapphire wafer in O₂ atmosphere. Vicinal *a*-plane sapphire wafer was specially ordered from a local company (Sichuan Oriental Stars Trading). To form uniform atomic steps on the entire wafer surface, the sapphire substrates were annealed at 1,140 °C in air for about 5 h.

Growth of single-crystal WS₂ monolayer on vicinal *a*-plane sapphire. The WS₂ monolayer films were grown on *a*-plane sapphire in a chemical vapour deposition (CVD) system with three temperature zones, namely, zones I–III. Sulfur (Alfa Aesar, 99.9%) powder was placed at the upstream end of a quartz tube and heated by a heating band. WO₃ (Alfa Aesar, 99.99%) powder and NaCl (Greagent, 99.95%) were placed in zone I of the tube furnace and sapphire substrates were placed in zone III. The CVD process was performed under low pressure in an argon (Ar) atmosphere. During the growth process, the temperature of the S source and the temperatures of zone I, zone II and zone III, were set at 125, 645, 850 and 965 °C, respectively, under a mixed-gas flow (Ar, 200 s.c.c.m.; H₂, 0–5 s.c.c.m.). The pressure in the growth chamber was kept at ~300 Pa. To obtain individual islands, the growth time was 5–20 min; for a continuous WS₂ film, the growth time was 1 h. After growth, the whole CVD system was cooled down to room temperature under an Ar gas flow (500 s.c.c.m.).

Growth of MoS₂, MoSe₂ and WSe₂ on vicinal *a*-plane sapphire. The growth recipes were very similar to that for WS₂, except for the replacement of WO₃ by MoO₃ source, S by Se source, and the temperature settings were accordingly adjusted. During MoS₂ growth, the temperature of the S source and temperatures of zone I, zone II and zone III were set at 125, 550, 850 and 965 °C, respectively, under an Ar gas flow (200 s.c.c.m.). During MoSe₂ growth, the temperature of the Se source and temperatures of zone I, zone II and zone III were set at 250, 550, 850 and 965 °C, respectively, under a mixed-gas flow (Ar, 200 s.c.c.m.; H₂, 5 s.c.c.m.). During WSe₂ growth, the temperature of the Se source and temperatures of zone I, zone II and zone III were set at 250, 645, 850 and 965 °C, respectively, under a mixed-gas flow (Ar, 160 s.c.c.m.; H₂, 40 s.c.c.m.).

Etching of WS₂ film to visualize grain boundaries. After growth, a mixed-gas flow comprising Ar and O₂ was introduced into the CVD system (Ar, 200 s.c.c.m.; O₂, 1–10 s.c.c.m.) for 5–30 min to etch holes in the continuous WS₂ film. By changing the O₂ concentration, temperature and etching time, the shape of the etched holes could be tuned from hexagonal to trapezoidal. To visualize the grain boundaries by optical microscopy, the as-grown large-area continuous WS₂ film was exposed to hot water vapour at 70 °C for 20 h to etch the defective grain boundaries.

Characterization.

- LEED measurements were performed using an Omicron LEED system in an ultrahigh vacuum with a base pressure of $<3 \times 10^{-7}$ Pa. Scanning electron microscopy (SEM) images were obtained using an FEI Nova NanoSEM 430 instrument. AFM measurements were performed using Asylum Research Cypher under ambient conditions.
- Optical measurements. Raman spectra were obtained with a home-made Raman system with a laser excitation wavelength of 532 nm and power of ~0.5 mW. Low-temperature PL spectra were obtained at 7.5 K using a home-made optical cryostat with a laser excitation wavelength of 532 nm and power of ~8 μW. Circular helicity of the films was probed under an off-resonant excitation photon energy of 2.34 eV. Polarized light was generated with a super-achromatic quarter-wave plate (Thorlabs SAQWP05M-700) and the PL was analysed through the same quarter-wave plate as well as a linear polarizer. SHG mapping was obtained using the same system under excitation from a femtosecond laser centred at 820 nm with an average power of 800 μW (Spectra-Physics InSight system with a pulse duration of 200 fs and repetition rate of 80 MHz). We used circularly polarized light to excite the SHG, and grain boundaries were visualized as dark lines in SHG imaging²⁵.
- TEM characterization. The WS₂ (MoS₂) sample for TEM characterization was prepared by transferring WS₂ (MoS₂) onto home-made monolayer graphene TEM grids using the polymethyl-methacrylate-based transfer technique. Graphene TEM grids were made by transferring large-area monolayer single-crystal graphene on commercial holey carbon TEM grids (Zhongjingkeyi GIG-2010-3C). Scanning transmission electron microscopy (STEM) experiments were performed using an FEI Titan Themis G2 300 system operated at 300 kV and a Nion U-HERMES200 system at 60 kV.
- X-ray diffraction measurements were conducted using a PANalytical Empyrean system with a copper target.

Computational details. Geometric optimization and energy calculations of WS₂/*a*-Al₂O₃ systems were carried out using DFT calculations as implemented in the Vienna ab initio simulation package^{34,35}. The Perdew–Burke–Ernzerhof functional with the generalized gradient approximation was adopted to treat the

exchange–correlation functional³⁶. To include van der Waals interactions between WS₂ and the substrate, the widely used dispersion-corrected DFT-D3 method was chosen³⁷. A plane-wave basis energy cutoff of 400 eV was used; the energies and forces were set to converge below a threshold of 10^{-4} eV and $0.01 \text{ eV } \text{Å}^{-1}$, respectively, to fully relax the structures in all the calculations. We chose the Gaussian smearing method. We constructed triangular WS₂ clusters (57 atoms) on *a*-Al₂O₃ with oxygen termination (stoichiometric surfaces, 360 atoms) and the size of the unit cell was $25.98 \text{ Å} \times 24.73 \text{ Å}$. Some atomic layers of *a*-Al₂O₃ were frozen (marked in Supplementary Fig. 25) to represent the sapphire surface, and a $1 \times 1 \times 1$ Monkhorst–Pack *k*-point mesh was adopted. The binding energies of the WS₂–substrate hybrid, namely, $E_b = (E_{\text{hyb}} - E_{\text{WS}_2} - E_{\text{sub}})/S$, was calculated using the relaxed structures, where E_{hyb} is the total energy of the hybrid; E_{WS_2} and E_{sub} represent the energies of WS₂ and the substrate, respectively; and S is the area of the WS₂ cluster. To estimate the sapphire step–WS₂ interaction, two antiparallel WS₂ nanoribbons with a length of about 1.7 nm (100 atoms) were placed on the $<1\bar{1}01>$ step of the vicinal *a*-Al₂O₃ surface (358 atoms) and then relaxed; the size of sapphire was $15.64 \text{ Å} \times 24.47 \text{ Å}$. The energy difference was defined as $\Delta E = (E_1 - E_2)/L$, where E_1 and E_2 are the total energies of the hybrid system, respectively, and L is the length of the nanoribbon. Similar calculations were also conducted for the MoS₂/*a*-Al₂O₃ systems.

To understand the formation mechanism of the trapezoidal shape of the WS₂ island, we modelled the diffusion of the S₂ dimer on the *a*-plane surface of sapphire, and the energy barrier of each reaction was calculated using the climbing image nudged elastic band approach³⁸. To understand the seamless stitching of the islands energetically, we modelled two possible cases of the stitching of two WS₂ islands (the length of one island is 16.53 nm) when they are away from each other with a WS₂ lattice constant of 1/2: (1) forming a line defect (5588 type) and (2) well-aligned structure with evenly distributed strain. The formation energy of the strained model is calculated as $E_{\text{strained}} = 1/2 \times C_{11} \times L \times h \times \epsilon^2$, where $C_{11} = 149 \text{ J m}^{-2}$, $h = 0.64 \text{ nm}$ and ϵ is the applied strain.

Data availability

Source data are provided with this paper. The data that support the findings of this study are available within the paper and Supplementary Information. Additional data are available from the corresponding authors upon reasonable request.

References

- Kresse, G. & Furthmüller, J. Efficiency of ab-initio total energy calculations for metals and semiconductors using a plane-wave basis set. *Comp. Mater. Sci.* **6**, 15–50 (1996).
- Kresse, G. & Furthmüller, J. Efficient iterative schemes for ab initio total-energy calculations using a plane-wave basis set. *Phys. Rev. B* **54**, 11169–11186 (1996).
- Perdew, J. P., Burke, K. & Ernzerhof, M. Generalized gradient approximation made simple. *Phys. Rev. Lett.* **77**, 3865–3868 (1996).
- Grimme, S., Antony, J., Ehrlich, S. & Krieg, H. A consistent and accurate ab initio parametrization of density functional dispersion correction (DFT-D) for the 94 elements H–Pu. *J. Chem. Phys.* **132**, 154104 (2010).
- Henkelman, G., Uberuaga, B. P. & Jonsson, H. A climbing image nudged elastic band method for finding saddle points and minimum energy paths. *J. Chem. Phys.* **113**, 9901–9904 (2000).

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Author contributions

K.L. conceived and supervised the project. J.W., X.X., Z.L., P.Z., G.C., C.C., C.L., Y. Zuo, G.X., M.W. and E.W. performed the sample growth. T.C. and F.D. performed the theoretical calculations. L.G., H.H., C.H., J. Liang, Z.T. and S.W. conducted the optical

measurements. R.Q., Y.G., D.Y. and P.G. conducted the TEM measurements. D.D., J.T., Z.Y., L.L., R.Y., G.Z. and J. Lu conducted the electrical measurements. Zhibin Zhang, Zhihong Zhang, S.Z., J.Q., Y. Zhao, Q.J. and Q.L. conducted the AFM measurements. X.X. and X.F. conducted the LEED measurements. All the authors discussed the results and wrote the manuscript.

Competing interests

The authors declare no competing interests.

Additional information

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